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Vishay Siliconix

Automotive N-Channel 100 V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY | | | |
|---|--------|--|--|
| V _{DS} (V) | 100 | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$ | 0.0095 | | |
| I _D (A) | 120 | | |
| Configuration | Single | | |
| Package | TO-263 | | |



FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- AEC-Q101 qualified d
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



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| N-Channel MOSFET | S |

| PARAMETER | | SYMBOL | LIMIT | UNIT |
|--|-------------------------------------|-----------------------------------|-------------|------|
| Drain-Source Voltage | | V _{DS} | 100 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| Continuous Drain Current | T _C = 25 °C ^a | 1 | 120 | |
| Continuous Drain Current | T _C = 125 °C | l _D | 73 | |
| Continuous Source Current (Diode Conduc | ction) ^a | I _S | 120 | Α |
| Pulsed Drain Current ^b | | I _{DM} | 480 | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 73 | |
| Single Pulse Avalanche Energy | L = U.1 MH | E _{AS} | 266 | mJ |
| Maximum Dawar Dissination b | T _C = 25 °C | D | 375 | W |
| Maximum Power Dissipation ^b | T _C = 125 °C | P_{D} | 125 | VV |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +175 | °C |

| THERMAL RESISTANCE RATINGS | | | | |
|----------------------------|-------------|------------|-------|------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Junction-to-Ambient | PCB Mount c | R_{thJA} | 40 | °C/W |
| Junction-to-Case (Drain) | | R_{thJC} | 0.4 | C/VV |

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.



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| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|--------------------------|--|--|------|--------|--------|------|
| Static | | | | | • | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} | = 0, I _D = 250 μA | 100 | - | - | V |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | | 2.5 | 3.0 | 3.5 | V |
| Gate-Source Leakage | I _{GSS} | V _{DS} = | 0 V, V _{GS} = ± 20 V | - | - | ± 100 | nA |
| | | $V_{GS} = 0 V$ | V _{DS} = 100 V | - | - | 1 | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{GS} = 0 V$ | V _{DS} = 100 V, T _J = 125 °C | - | - | 50 | μΑ |
| | | V _{GS} = 0 V | V _{DS} = 100 V, T _J = 175 °C | - | - | 150 | |
| On-State Drain Current ^a | I _{D(on)} | V _{GS} = 10 V | $V_{DS} \ge 5 V$ | 120 | - | - | Α |
| | | V _{GS} = 10 V | I _D = 30 A | - | 0.0079 | 0.0095 | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V | I _D = 30 A, T _J = 125 °C | - | - | 0.0190 | Ω |
| | | V _{GS} = 10 V | I _D = 30 A, T _J = 175 °C | - | - | 0.0250 | 1 |
| Forward Transconductance b | 9 _{fs} | V _{DS} | = 15 V, I _D = 30 A | - | 99 | - | S |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | - | 6915 | 8645 | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V$ | $V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | - | 635 | 795 | pF |
| Reverse Transfer Capacitance | C _{rss} | 1 | | - | 280 | 350 | |
| Total Gate Charge ^c | Qg | | | - | 120 | 180 | |
| Gate-Source Charge ^c | Q _{gs} | V _{GS} = 10 V | $V_{DS} = 50 \text{ V}, I_{D} = 85 \text{ A}$ | - | 30 | - | nC |
| Gate-Drain Charge ^c | Q _{gd} | 1 | | - | 28.5 | - | |
| Gate Resistance | R _g | | f = 1 MHz | 0.25 | 0.7 | 2.3 | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | | - | 21 | 32 | |
| Rise Time ^c | t _r | V _{DD} : | = 50 V, $R_L = 0.6 \Omega$ | - | 24 | 36 | no |
| Turn-Off Delay Time ^c | t _{d(off)} | I _D ≅ 85 A, \ | $V_{\rm GEN} = 10$ V, $R_{\rm g} = 2.5 \Omega$ | - | 52 | 78 | ns |
| Fall Time ^c | t _f | | | - | 16 | 24 | 1 |
| Source-Drain Diode Ratings and Chara | icteristics ^b | | | | • | | |
| Pulsed Current ^a | I _{SM} | | | - | - | 480 | Α |
| Forward Voltage | V _{SD} | I _F = 85 A, V _{GS} = 0 | | | 0.9 | 1.5 | V |

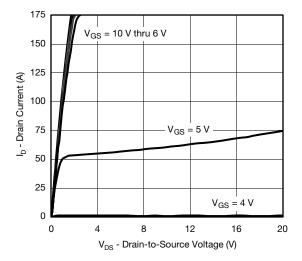
Notes

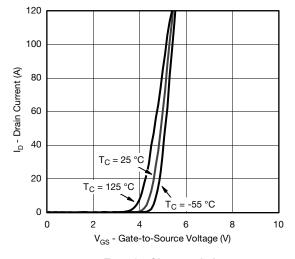
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



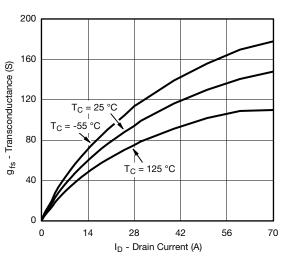
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

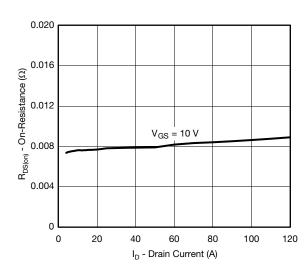




Output Characteristics

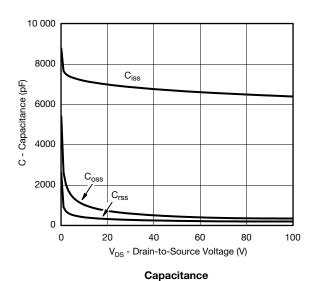


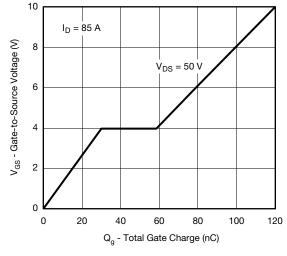




Transconductance

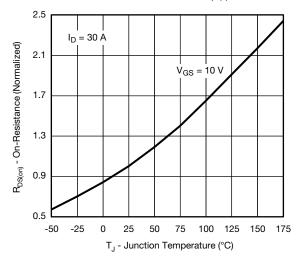
On-Resistance vs. Drain Current



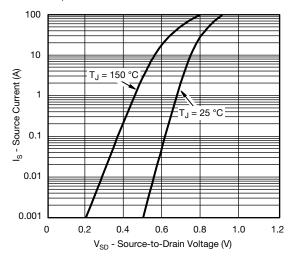




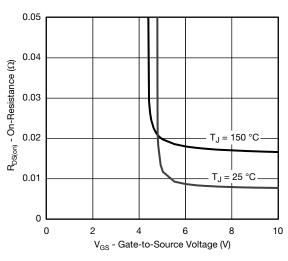
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



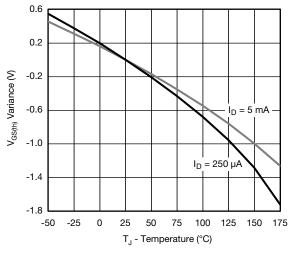
On-Resistance vs. Junction Temperature



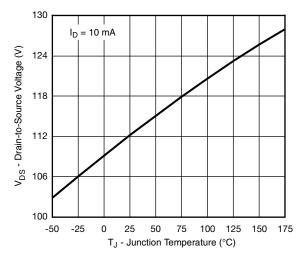
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

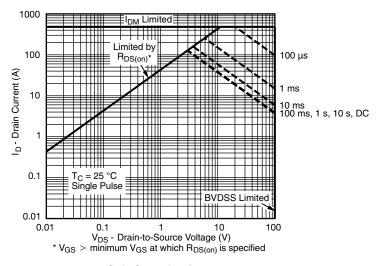


Drain Source Breakdown vs. Junction Temperature

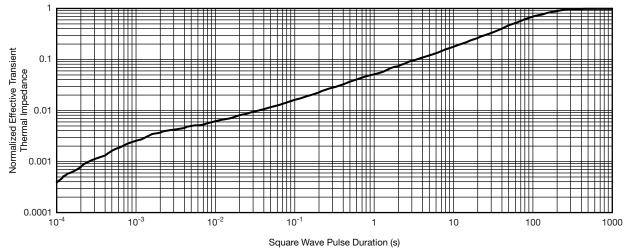
For technical questions, contact: automostechsu



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



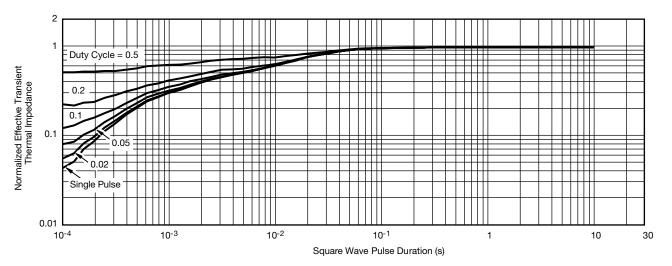
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg271515.



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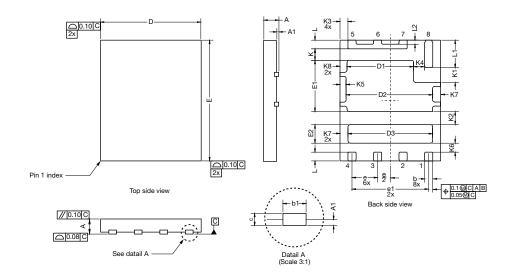
| REVISION | REVISION HISTORY ^a | | | | |
|----------|-------------------------------|--------------------------------------|--|--|--|
| REVISION | DATE | DESCRIPTION OF CHANGE | | | |
| С | 04-Aug-15 | Revised R _g minimum limit | | | |

Note

a. As of April 2014



PowerPAIR® 6 x 5 F Case Outline



| DIMENSION | MILLIMETERS | | | INCHES | | |
|-----------|-------------|-----------|------|--------|------------|-------------|
| DIMENSION | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| Α | 0.70 | 0.75 | 0.80 | 0.028 | 0.030 | 0.031 |
| A1 | 0.00 | - | 0.10 | 0.000 | - | 0.004 |
| b | 0.35 | 0.41 | 0.46 | 0.014 | 0.016 | 0.018 |
| b1 | | 0.38 ref. | | | 0.015 ref. | |
| С | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 4.90 | 5.00 | 5.10 | 0.193 | 0.197 | 0.201 |
| D1 | 3.26 | 3.31 | 3.36 | 0.128 | 0.130 | 0.132 |
| D2 | 4.20 | 4.30 | 4.40 | 0.165 | 0.169 | 0.173 |
| D3 | 4.15 | 4.20 | 4.25 | 0.163 | 0.165 | 0.167 |
| Е | 5.90 | 6.00 | 6.10 | 0.232 | 0.236 | 0.240 |
| E1 | 2.50 | 2.55 | 2.60 | 0.098 | 0.100 | 0.102 |
| E2 | 0.87 | 0.92 | 0.97 | 0.034 | 0.036 | 0.038 |
| е | 1.27 BSC | | | | 0.050 BSC | |
| e1 | | 3.81 BSC | | | 0.150 BSC | |
| K | 0.52 | 0.57 | 0.62 | 0.020 | 0.022 | 0.024 |
| K1 | 0.69 | 0.74 | 0.79 | 0.027 | 0.029 | 0.031 |
| K2 | 0.60 | 0.65 | 0.70 | 0.024 | 0.026 | 0.028 |
| K3 | | 0.39 BSC | | | 0.015 BSC | |
| K4 | 0.50 | 0.55 | 0.60 | 0.020 | 0.022 | 0.024 |
| K5 | 0.25 | 0.30 | 0.35 | 0.010 | 0.012 | 0.014 |
| K6 | 0.40 | 0.45 | 0.50 | 0.016 | 0.018 | 0.020 |
| K7 | 0.35 | 0.40 | 0.45 | 0.014 | 0.016 | 0.018 |
| K8 | 0.30 | 0.35 | 0.40 | 0.012 | 0.014 | 0.016 |
| L | 0.33 | 0.43 | 0.53 | 0.013 | 0.017 | 0.021 |
| L1 | 1.31 | 1.36 | 1.41 | 0.052 | 0.054 | 0.056 |
| L2 | | 0.20 ref. | | | 0.008 ref. | |

ECN: T20-0097-Rev. C, 25-Feb-2020

DWG: 6043

Note

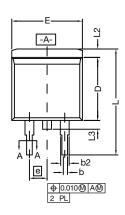
• Millimeters will govern

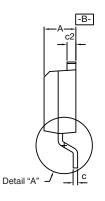
Revision: 25-Feb-2020 1 Document Number: 67777

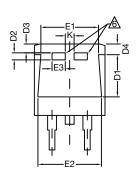
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TO-263 (D²PAK): 3-LEAD

VERSION 1: FACILITY CODE = T









DETAIL A (ROTATED 90°)



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| SF | CTION | 1 | 1 |

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

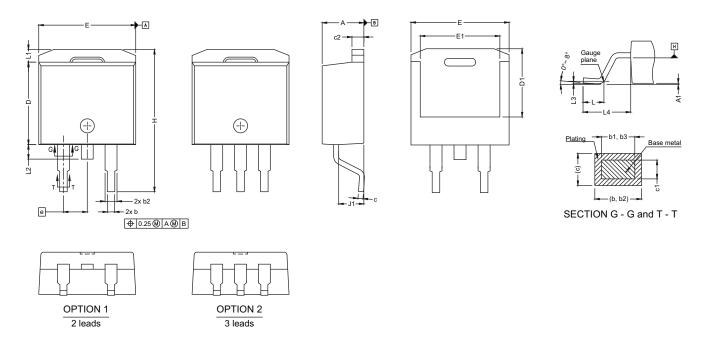
| | | INCHES | | MILLIN | METERS |
|----|------------|---------------|-------|----------|--------|
| | DIM. | MIN. | MAX. | MIN. | MAX. |
| | Α | 0.160 | 0.190 | 4.064 | 4.826 |
| | b | 0.020 | 0.039 | 0.508 | 0.990 |
| | b1 | 0.020 | 0.035 | 0.508 | 0.889 |
| | b2 | 0.045 | 0.055 | 1.143 | 1.397 |
| C* | Thin lead | 0.013 | 0.018 | 0.330 | 0.457 |
| C | Thick lead | 0.023 | 0.028 | 0.584 | 0.711 |
| c1 | Thin lead | 0.013 | 0.017 | 0.330 | 0.431 |
| CI | Thick lead | 0.023 | 0.027 | 0.584 | 0.685 |
| | c2 | 0.045 | 0.055 | 1.143 | 1.397 |
| | D | 0.340 | 0.380 | 8.636 | 9.652 |
| | D1 | 0.220 | 0.240 | 5.588 | 6.096 |
| | D2 | 0.038 | 0.042 | 0.965 | 1.067 |
| | D3 | 0.045 | 0.055 | 1.143 | 1.397 |
| | D4 | 0.044 | 0.052 | 1.118 | 1.321 |
| | E | 0.380 | 0.410 | 9.652 | 10.414 |
| E1 | | 0.245 | - | 6.223 | - |
| | E2 | 0.355 | 0.375 | 9.017 | 9.525 |
| | E3 | 0.072 | 0.078 | 1.829 | 1.981 |
| | е | 0.100 BSC | | 2.54 BSC | |
| K | | 0.045 | 0.055 | 1.143 | 1.397 |
| L | | L 0.575 | | 14.605 | 15.875 |
| L1 | | 0.090 | 0.110 | 2.286 | 2.794 |
| L2 | | L2 0.040 0.05 | | 1.016 | 1.397 |
| | L3 | 0.050 | 0.070 | 1.270 | 1.778 |
| | L4 | 0.010 | BSC | 0.254 | BSC |
| | М | - | 0.002 | - | 0.050 |



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VERSION 2: FACILITY CODE = N



| DIM. | MIN. | MAX. |
|------|-----------|-------|
| A | 4.36 | 4.56 |
| A1 | 0 | 0.25 |
| b | 0.70 | 0.90 |
| b1 | 0.51 | 0.89 |
| b2 | 1.20 | 1.46 |
| b3 | 1.17 | 1.37 |
| С | 0.38 | 0.694 |
| c1 | 0.38 | 0.534 |
| c2 | 1.19 | 1.34 |
| D | 8.60 | 9.00 |
| D1 | 6.9 | 7.5 |
| E | 10.15 | 10.55 |
| E1 | 8.1 | 8.7 |
| е | 2.54 | BSC |
| Н | 15.0 | 15.6 |
| L | 1.9 | 2.5 |
| L1 | - | 1.65 |
| L2 | - | 1.78 |
| L3 | 0.25 typ. | |
| L4 | 4.78 5.28 | |
| J1 | 2.56 | 2.96 |

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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